GUJARAT TECHNOLOGICAL UNIVERSITY

		GUJARAT TECHNOLOGICAL UNIVERSITY e - semester–vii (new) examination – summer 202			
Subject Code:3171926 Date:0					
Subje	ct Na	me:Rapid Prototyping			
Time:02:30 PM TO 05:00 PMTotal Mark					
Instruct		tempt all questions.			
	2. Ma	ake suitable assumptions wherever necessary.			
		gures to the right indicate full marks. nple and non-programmable scientific calculators are allowed.			
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Q.1	(a) (b)	What is Prototyping? Enlist advantages of Rapid Prototyping. Compare Additive and Subtractive techniques in terms of Accuracy & Repeatability.	03 04		
	(c)	Explain the steps for typical Rapid Prototyping Process.	07		
Q.2	(a)	Describe the STL file format. Explain the importance of STL file in RP.	03		
	(b)	Differentiate uniform slicing and adaptive slicing with suitable example.	04		
	(c)	Explain the strengths and weaknesses of CLI & HP/GL file formats.	07		
	<i>.</i> .	OR	. –		
	(c)	Differentiate RPI and STL file format in terms of advantages & disadvantages.	07		
Q.3	(a)	Define the following terms.	03		
		 Chord Height Staircase effect Infill 			
	(b)	Explain the importance of part orientation in 3D printing with suitable example.	04		
	(c)	Define & classify Rapid Tooling. Explain any one Method of Direct Tooling.	07		
		OR			
Q.3	(a)	Enlist the Applications for Direct Metal Deposition (DMD) process.	03		
	(b)	Explain about photo polymerization process with neat sketch.	04		
	(c)	Define & classify Rapid Tooling. Explain any one method of Indirect Tooling.	07		
Q.4	(a)	Enlist the Applications for Selective Laser Sintering (SLS)	03		
	(b)	process. Explain different Part Building errors in RP.	04		
	(D) (C)	Explain Fused Deposition Modelling (FDM) RP process with neat	07		
		sketch.	÷ -		
0.4			0.2		
Q.4	(a)	Enlist the advantages and limitation for Laminated object manufacturing (LOM) process.	03		
	(b) (c)	Discuss the various post-processing errors occur in RP methods. Explain Stereolithography (SLA) process RP process with neat	04 07		
		sketch.	07		

Q.5	(a)	Write down the principle of Electron Beam Melting (EBM)	03
	(b)	Process. Explain RP applications for automotive industries.	04
	(c)	Define reverse engineering. Enlist various steps of reverse engineering and explain any one non-contact type method for acquiring point cloud data.	07
		OR	
Q.5	(a)	Write down the principle of Electron Beam Melting (EBM) Process.	03
	(b)	Enlist & explain the RP applications in the field of manufacturing & tooling.	04
	(c)	Explain different applications of RP in Medical field.	07
